Eda For Ic Implementation Circuit Design And Process Technology Electronic Design Automation For Integrated Circuits Hdbk

This book introduces readers to a variety of tools for analog layout design automation. After discussing the placement and routing problem in electronic design automation (EDA), the authors overview a variety of automatic layout generation tools, as well as the most recent advances in analog layout-aware circuit sizing. The discussion includes different methods for automatic placement (a template-based Placer and an optimization-based Placer), a fully-automatic Router and an empirical-based Parasitic Extractor. The concepts and algorithms of all the modules are thoroughly described, enabling readers to reproduce the methodologies, improve the quality of their designs, or use them as starting point for a new tool. All the methods described are applied to practical examples for a 130nm design process, as well as placement and routing benchmark sets.

Despite the fact that in the digital domain, designers can take full benefits of IPs and design automation tools to synthesize and design very complex systems, the analog designers' task is still considered as a 'handcraft', cumbersome and very time consuming process. Thus, tremendous efforts are being deployed to develop new design methodologies in the analog/RF and mixed-signal domains. This book collects 16 state-of-the-art contributions devoted to the topic of systematic design of analog, RF and mixed signal circuits. Divided in the two parts Methodologies and Techniques recent theories, synthesis techniques and design methodologies, as well as new sizing approaches in the field of robust analog and mixed signal design automation are presented for researchers and R/D engineers.

This book constitutes the refereed proceedings of the European Design Science Symposium, EDSS 2011, held in Leixlip, Ireland, in October 2011 held in conjunction with the Intel European Research and Innovation Conference, ERIC 2011. The 15 revised full papers presented were carefully reviewed and selected from various submissions. The papers are organized in topical sections on design science and processes; evaluation and utility; and applying design science.

Field Programmable Gate Arrays (FPGAs) are devices that provide a fast, low-cost way for embedded system designers to customize products and deliver new versions with upgraded features, because they can handle very complicated functions, and be reconfigured an infinite number of times. In addition to introducing the various architectural features available in the latest generation of FPGAs, The Design Warrior's Guide to FPGAs also covers different design tools and flows. This book covers information ranging from schematic-driven entry, through traditional HDL/RTL-based simulation and logic synthesis, all the way up to the current state-of-the-art in pure C/C++ design capture and synthesis technology. Also discussed are specialist areas such as mixed hardward/software and DSP-based design flows, along with innovative new devices such as field programmable node arrays (FPNAs). Clive "Max" Maxfield is a bestselling author and engineer with a large following in the electronic design automation (EDA)and embedded systems industry. In this comprehensive book, he covers all the issues of interest to designers working with, or contemplating a move to, FPGAs in their product designs. While other books cover fragments of FPGA technology or applications this is the first to focus exclusively and comprehensively on FPGA use for embedded systems. First book to focus exclusively and comprehensively on FPGA use in embedded designs World-renowned best-selling author Will help engineers get familiar and succeed with this new technology by providing much-needed advice on choosing the right FPGA for any design project

Nowadays energy crisis and global warming problems are hanging over everyone's head, urging much research work on energy saving. In the ICT industry, which is becoming a major consumer of global energy triggered by the telecommunication network operators experiencing energy cost as a significant factor in profit calculations, researchers have started to investigate various approaches for power consumption reduction. Standards bodies are already developing standards for energy-efficient protocols. However, research in green communications is still at an early stage, and the space of potential solutions is far from being fully explored. This book provides a comprehensive discussion of academic research and relevant applications in green communications. It aims to increase understanding of relevant issues and further the development of strategies and techniques. Gathering efforts from world-leading experts on green topics with different focuses, such as mobile communications, wireless networks, ad hoc and sensor networks, cloud computing, optical networking, smart grids, network devices, even FPGA and terminal devices, combined with the best practices from the largest telecommunication operator, China Mobile Corporation, this book covers key features such as: Not only focuses on energy saving of ICT industry, but also figures out its role to help other industries reduce energy consumption Comprehensively covers almost all main aspects in green communications Includes recent advances in theoretical analysis, algorithms, and practical applications for green wired and wireless communications Readers do not have to be professionals in communications to understand the basic ideas in the book This book brings green wired and wireless communications, as well as other general green topics, in one book, which will give readers a panoramic view in the relevant green fields.

Compact Models for Integrated Circuit Design: Conventional Transistors and Beyond provides a modern treatise on compact models for circuit computer-aided design (CAD). Written by an author with more than 25 years of industry experience in semiconductor processes, devices, and circuit CAD, and more than 10 years of academic experience in teaching compact modeling courses, this first-of-its-kind book on compact SPICE models for very-large-scale-integrated (VLSI) chip design offers a balanced presentation of compact modeling crucial for addressing current modeling challenges and understanding new models for emerging devices. Starting from basic semiconductor physics and covering state-of-the-art device regimes from conventional micron to nanometer, this text: Presents industry standard models for bipolar-junction transistors (BJTs), metal-oxide-semiconductor (MOS) field-effect-transistors (FETs), FinFETs, and tunnel field-effect transistors (TFETs), along with statistical MOS models Discusses the major issue of process variability, which severely impacts device and circuit performance in advanced technologies and requires statistical compact models Promotes further research of the evolution and development of compact models for VLSI circuit design and analysis Supplies fundamental and practical knowledge necessary for efficient integrated circuit (IC) design using nanoscale devices Includes exercise problems at the end of each chapter and extensive references at the end of the book Compact Models for Integrated Circuit Design: Conventional Transistors and Beyond is intended for senior undergraduate and graduate courses in electrical and electronics engineering as well as for researchers and practitioners working in the area of electron devices. However, even those unfamiliar with semiconductor physics gain a solid grasp of compact modeling concepts from this book. The Open Access version of this book, available at https://doi.org/10.1201/b19117, has been

made available under a Creative Commons Attribution-Non Commercial-No Derivatives 4.0 license.

This book provides broad and comprehensive coverage of the entire EDA flow. EDA/VLSI practitioners and researchers in need of fluency in an "adjacent" field will find this an invaluable reference to the basic EDA concepts, principles, data structures, algorithms, and architectures for the design, verification, and test of VLSI circuits. Anyone who needs to learn the concepts, principles, data structures, algorithms, and architectures of the EDA flow will benefit from this book. Covers complete spectrum of the EDA flow, from ESL design modeling to logic/test synthesis, verification, physical design, and test - helps EDA newcomers to get "up-and-running" quickly Includes comprehensive coverage of EDA concepts, principles, data structures, algorithms, and architectures - helps all readers improve their VLSI design competence Contains latest advancements not yet available in other books, including Test compression, ESL design modeling, large-scale floorplanning, placement, routing, synthesis of clock and power/ground networks - helps readers to design/develop testable chips or products Includes industry best-practices wherever appropriate in most chapters - helps readers avoid costly mistakes

This book was written to arm engineers qualified and knowledgeable in the area of VLSI circuits with the essential knowledge they need to get into this exciting field and to help those already in it achieve a higher level of proficiency. Few people truly understand how a large chip is developed, but an understanding of the whole process is necessary to appreciate the importance of each part of it and to understand the process from concept to silicon. It will teach readers how to become better engineers through a practical approach of diagnosing and attacking real-world problems.

Single-threaded software applications have ceased to see signi?cant gains in p- formance on a general-purpose CPU, even with further scaling in very large scale integration (VLSI) technology. This is a signi?cant problem for electronic design automation (EDA) applications, since the design complexity of VLSI integrated circuits (ICs) is continuously growing. In this research monograph, we evaluate custom ICs, ?eld-programmable gate arrays (FPGAs), and graphics processors as platforms for accelerating EDA algorithms, instead of the general-purpose sing- threaded CPU. We study applications which are used in key time-consuming steps of the VLSI design ?ow. Further, these applications also have different degrees of inherent parallelism in them. We study both control-dominated EDA applications and control plus data parallel EDA applications. We accelerate these applications on these different hardware platforms. We also present an automated approach for accelerating certain uniprocessor applications on a graphics processor. This monograph compares custom ICs, FPGAs, and graphics processing units (GPUs) as potential platforms to accelerate EDA algorithms. It also provides details of the programming model used for interfacing with the GPUs.

EDA for IC Implementation, Circuit Design, and Process TechnologyCRC Press

With the proliferation of VHDL, the reference material also grew in the same order. Today there is good amount of scholarly literature including many books describing various aspects of VHDL. However, an indepth review of these books reveals a different story. Many of them have emerged simply as an improved version of the manual. While some of them deal with the system design issues, they lack appropriate exemplifying to illustrate the concepts. Others give large number of examples, but lack the VLSI system design issues. In nutshell, the fact which gone unnoticed by most of the books, is the growth of the VLSI is not merely due to the language itself, but more due to the development of large number of third party tools useful from the FPGA or semicustom ASIC realization point of view. In the proposed book, the authors have synergized the VHDL programming with appropriate EDA tools so as to present a full proof system design to the readers. In this book along with the VHDL coding issues, the simulation and synthesis with the various toolsets enables the potential reader to visualize the final design. The VHDL design codes have been synthesized using different third party tools such as Xilinx Web pack Ver.11, Modelsim PE, Leonrado Spectrum and Synplify Pro. Mixed flow illustrated by using the above mentioned tools presents an insight to optimize the design with reference to the spatial, temporal and power metrics.

Presenting a comprehensive overview of the design automation algorithms, tools, and methodologies used to design integrated circuits, the Electronic Design Automation for Integrated Circuits Handbook is available in two volumes. The second volume, EDA for IC Implementation, Circuit Design, and Process Technology, thoroughly examines real-time logic to GDSII (a file format used to transfer data of semiconductor physical layout), analog/mixed signal design, physical verification, and technology CAD (TCAD). Chapters contributed by leading experts authoritatively discuss design for manufacturability at the nanoscale, power supply network design and analysis, design modeling, and much more. Save on the complete set.

We live in a time of great change. In the electronics world, the last several decades have seen unprecedented growth and advancement, described by Moore’s law. This observation stated that transistor density in integrated circuits doubles every 1. 5–2 years. This came with the simultaneous improvement of individual device perf- mance as well as the reduction of device power such that the total power of the resulting ICs remained under control. No trend remains constant forever, and this is unfortunately the case with Moore’s law. The trouble began a number of years ago when CMOS devices were no longer able to proceed along the classical scaling trends. Key device parameters such as gate oxide thickness were simply no longer able to scale. As a result, device o- state currents began to creep up at an alarming rate. These continuing problems with classical scaling have led to a leveling off of IC clock speeds to the range of several GHz. Of course, chips can be clocked higher but the thermal issues become unmanageable. This has led to the recent trend toward microprocessors with mul- ple cores, each running at a few GHz at the most. The goal is to continue improving performance via parallelism by adding more and more cores instead of increasing speed. The challenge here is to ensure that general purpose codes can be ef?ciently parallelized. There is another potential solution to the problem of how to improve CMOS technology performance: three-dimensional integrated circuits (3D ICs).

This book describes reliable and efficient design automation techniques for the design and implementation of an approximate computing system. The authors address the important facets of approximate computing hardware design - from formal verification and error guarantees to synthesis and test of approximation systems. They provide algorithms and methodologies based on classical formal verification, synthesis and test techniques for an approximate computing IC design flow. This is one of the first books in Approximate Computing that addresses the design automation aspects, aiming for not only sketching the possibility, but providing a comprehensive overview of different tasks and especially how they can be implemented.

Praise for CMOS: Circuit Design, Layout, and SimulationRevised Second Edition from the Technical Reviewers "A refreshing industrial flavor. Design concepts are presented as they are needed for 'just-in-time' learning. Simulating and designing circuits using SPICE is emphasized with literally hundreds of examples. Very few textbooks contain as much detail as this one. Highly recommended!" --Paul M. Furth, New Mexico State University "This book builds a solid knowledge of CMOS circuit design from the ground up. With coverage of process integration, layout, analog and digital models, noise mechanisms, memory circuits, references, amplifiers, PLLs/DLLs, dynamic circuits, and data converters, the text is an excellent reference for both experienced and novice designers alike." --Tyler J. Gomm, Design Engineer, Micron Technology, Inc. "The Second Edition builds upon the success of the first with new chapters that cover additional material such as oversampled converters and non-volatile memories. This is becoming the de facto standard textbook to have on every analog and mixed-signal designer's bookshelf." --Joe Walsh, Design Engineer, AMI Semiconductor CMOS circuits from design to implementation CMOS: Circuit Design, Layout, and Simulation, Revised Second Edition covers the practical design of both analog and digital integrated circuits, offering a vital, contemporary view of a wide range of analog/digital circuit blocks, the BSIM model, data converter architectures, and much more. This

edition takes a two-path approach to the topics: design techniques are developed for both long- and short-channel CMOS technologies and then compared. The results are multidimensional explanations that allow readers to gain deep insight into the design process. Features include: Updated materials to reflect CMOS technology's movement into nanometer sizes Discussions on phase- and delay-locked loops, mixed-signal circuits, data converters, and circuit noise More than 1,000 figures, 200 examples, and over 500 end-of-chapter problems In-depth coverage of both analog and digital circuit-level design techniques Real-world process parameters and design rules The book's Web site, CMOSedu.com, provides: solutions to the book's problems; additional homework problems without solutions; SPICE simulation examples using HSPICE, LTspice, and WinSpice; layout tools and examples for actually fabricating a chip; and videos to aid learning

The physical design flow of any project depends upon the size of the design, the technology, the number of designers, the clock frequency, and the time to do the design. As technology advances and design-styles change, physical design flows are constantly reinvented as traditional phases are removed and new ones are added to accommodate changes in technology. Handbook of Algorithms for Physical Design Automation provides a detailed overview of VLSI physical design automation, emphasizing state-of-the-art techniques, trends and improvements that have emerged during the previous decade. After a brief introduction to the modern physical design problem, basic algorithmic techniques, and partitioning, the book discusses significant advances in floorplanning representations and describes recent formulations of the floorplanning problem. The text also addresses issues of placement, net layout and optimization, routing multiple signal nets, manufacturability, physical synthesis, special nets, and designing for specialized technologies. It includes a personal perspective from Ralph Otten as he looks back on the major technical milestones in the history of physical design automation. Although several books on this topic are currently available, most are either too broad or out of date. Alternatively, proceedings and journal articles are valuable resources for researchers in this area, but the material is widely dispersed in the literature. This handbook pulls together a broad variety of perspectives on the most challenging problems in the field, and focuses on emerging problems and research results.

Mixed-Signal Circuits offers a thoroughly modern treatment of integrated circuit design in the context of mixed-signal applications. Featuring chapters authored by leading experts from industry and academia, this book: Discusses signal integrity and large-scale simulation, verification, and testing Demonstrates advanced design techniques that enable digital circuits and sensitive analog circuits to coexist without any compromise Describes the process technology needed to address the performance challenges associated with developing complex mixed-signal circuits Deals with modeling topics, such as reliability, variability, and crosstalk, that define pre-silicon design methodology and trends, and are the focus of companies involved in wireless applications Develops methods to move analog into the digital domain quickly, minimizing and eliminating common trade-offs between performance, power consumption, simulation time, verification, size, and cost Details approaches for very low-power performances, high-speed interfaces, phase-locked loops (PLLs), voltage-controlled oscillators (VCOs), analog-to-digital converters (ADCs), and biomedical filters Delineates the respective parts of a full system-on-chip (SoC), from the digital parts to the baseband blocks, radio frequency (RF) circuitries, electrostatic-discharge (ESD) structures, and built-in self-test (BIST) architectures Mixed-Signal Circuits explores exciting opportunities in wireless communications and beyond. The book is a must for anyone involved in mixed-signal circuit design for future technologies.

This peer-reviewed book explores the methodologies that are used for effective research, design and innovation in the vast field of millimeter-wave circuits, and describes how these have to be modified to fit the uniqueness of high-frequency nanoelectronics design. Each chapter focuses on a specific research challenge related to either small form factors or higher operating frequencies. The book first examines nanodevice scaling and the emerging electronic design automation tools that can be used in millimeter-wave research, as well as the singular challenges of combining deep-submicron and millimeter-wave design. It also demonstrates the importance of considering, in the millimeter-wave context, system-level design leading to differing packaging options. Further, it presents integrated circuit design methodologies for all major transceiver blocks typically employed at millimeter-wave frequencies, as these methodologies are normally fundamentally different from the traditional design methodologies used in analogue and lower-frequency electronics. Lastly, the book discusses the methodologies of millimeter-wave research and design for extreme or harsh environments, rebooting electronics, the additional opportunities for terahertz research, and the main differences between the approaches taken in millimeter-wave research and terahertz research.

Globalization of the integrated circuit (IC) supply chains led to many potential vulnerabilities. Several attack scenarios can exploit these vulnerabilities to reverse engineer IC designs or to insert malicious trojan circuits. Split manufacturing refers to the process of splitting an IC design into multiple parts and fabricating these parts at two or more foundries such that the design is secure even when some or all of those foundries are potentially untrusted. Realizing its security benefits, researchers have proposed split fabrication methods for 2D, 2.5D, and the emerging 3D ICs. Both attack methods against split designs and defense techniques to thwart those attacks while minimizing overheads have steadily progressed over the past decade. This book presents a comprehensive review of the state-of-the-art and emerging directions in design splitting for secure split fabrication, design recognition and recovery attacks against split designs, and design techniques to defend against those attacks. Readers will learn methodologies for secure and trusted IC design and fabrication using split design methods to protect against supply chain vulnerabilities. Provides the first book on Split Manufacturing methods, attacks and defenses for integrated circuits; Serves as single-source reference to all advances to-date on split manufacturing methods and design splitting techniques for 2D, 2.5D and 3D integrated circuits, design recovery attacks and defense methods; Covers design constraint based attacks and satisfiability based attacks to reverse engineer split designs or to insert hardware trojans; Covers design-for-trust defense techniques to thwart both reverse engineering and trojan insertion attacks; Discusses the security benefits and cost penalties of various split design methods; Includes challenges and emerging research directions.

Power Management Integrated Circuits and Technologies delivers a modern treatise on mixed-signal integrated circuit design for power management. Comprised of chapters authored by leading researchers from industry and academia, this definitive text: Describes circuit- and architectural-level innovations that meet advanced power and speed capabilities Explores hybrid inductive-capacitive converters for wide-range dynamic voltage scaling Presents innovative control techniques for single inductor dual output (SIDO) and single inductor multiple output (SIMO) converters Discusses cutting-edge design techniques including switching converters for analog/RF loads Compares the use of GaAs pHEMTs to CMOS devices for efficient high-frequency switching converters Thus, Power Management Integrated Circuits and Technologies provides comprehensive, state-of-the-art coverage of this exciting and emerging field of engineering.

Using the book and the software provided with it, the reader can build his/her own tester arrangement to investigate key aspects of analog-, digital- and mixed system circuits Plan of attack based on traditional testing, circuit design and circuit manufacture allows the reader to appreciate a testing regime from the point of view of all the participating interests Worked examples based on

theoretical bookwork, practical experimentation and simulation exercises teach the reader how to test circuits thoroughly and effectively

Electronic design automation (EDA) is among the crown jewels of electrical engineering. Without EDA tools, today's complex integrated circuits (ICs) would be impossible. Doesn't such an important field deserve a comprehensive, in-depth, and authoritative reference? The Electronic Design Automation for Integrated Circuits Handbook is that reference, ranging from system design through physical implementation. Organized for convenient access, this handbook is available as a set of two carefully focused books dedicated to the front- and back-end aspects of EDA, respectively. What's included in the Handbook? EDA for IC System Design, Verification, and Testing This first installment examines logical design, focusing on system-level and micro-architectural design, verification, and testing. It begins with a general overview followed by application-specific tools and methods, specification and modeling languages, high-level synthesis approaches, power estimation methods, simulation techniques, and testing procedures. EDA for IC Implementation, Circuit Design, and Process Technology Devoted to physical design, this second book analyzes the classical RTL to GDS II design flow, analog and mixed-signal design, physical verification, analysis and extraction, and technology computer aided design (TCAD). It explores power analysis and optimization, equivalence checking, placement and routing, design closure, design for manufacturability, process simulation, and device modeling. Comprising the work of expert contributors guided by leaders in the field, the Electronic Design Automation for Integrated Circuits Handbook provides a foundation of knowledge based on fundamental concepts and current industrial applications. It is an ideal resource for designers and users of EDA tools as well as a detailed introduction for newcomers to the field.

Design and optimization of integrated circuits are essential to the creation of new semiconductor chips, and physical optimizations are becoming more prominent as a result of semiconductor scaling. Modern chip design has become so complex that it is largely performed by specialized software, which is frequently updated to address advances in semiconductor technologies and increased problem complexities. A user of such software needs a high-level understanding of the underlying mathematical models and algorithms. On the other hand, a developer of such software must have a keen understanding of computer science aspects, including algorithmic performance bottlenecks and how various algorithms operate and interact. "VLSI Physical Design: From Graph Partitioning to Timing Closure" introduces and compares algorithms that are used during the physical design phase of integrated-circuit design, wherein a geometric chip layout is produced starting from an abstract circuit design. The emphasis is on essential and fundamental techniques, ranging from hypergraph partitioning and circuit placement to timing closure.

The first of two volumes in the Electronic Design Automation for Integrated Circuits Handbook, Second Edition, Electronic Design Automation for IC System Design, Verification, and Testing thoroughly examines system-level design, microarchitectural design, logic verification, and testing. Chapters contributed by leading experts authoritatively discuss processor modeling and design tools, using performance metrics to select microprocessor cores for integrated circuit (IC) designs, design and verification languages, digital simulation, hardware acceleration and emulation, and much more. New to This Edition: Major updates appearing in the initial phases of the design flow, where the level of abstraction keeps rising to support more functionality with lower non-recurring engineering (NRE) costs Significant revisions reflected in the final phases of the design flow, where the complexity due to smaller and smaller geometries is compounded by the slow progress of shorter wavelength lithography New coverage of cutting-edge applications and approaches realized in the decade since publication of the previous edition—these are illustrated by new chapters on high-level synthesis, system-on-chip (SoC) block-based design, and back-annotating system-level models Offering improved depth and modernity, Electronic Design Automation for IC System Design, Verification, and Testing provides a valuable, state-of-the-art reference for electronic design automation (EDA) students, researchers, and professionals.

Integrated circuits are fundamental electronic components in biomedical, automotive and many other technical systems. A small, yet crucial part of a chip consists of analog circuitry. This part is still in large part designed by hand and therefore represents not only a bottleneck in the design flow, but also a permanent source of design errors responsible for re-designs, costly in terms of wasted test chips and in terms of lost time-to-market. Layout design is the step of the analog design flow with the least support by commercially available, computer-aided design tools. This book provides a survey of promising new approaches to automated, analog layout design, which have been described recently and are rapidly being adopted in industry.

This hands-on introduction to silicon photonics engineering equips students with everything they need to begin creating foundry-ready designs.

The Complete, Modern Tutorial on Practical VLSI Chip Design, Validation, and Analysis As microelectronics engineers design complex chips using existing circuit libraries, they must ensure correct logical, physical, and electrical properties, and prepare for reliable foundry fabrication. VLSI Design Methodology Development focuses on the design and analysis steps needed to perform these tasks and successfully complete a modern chip design. Microprocessor design authority Tom Dillinger carefully introduces core concepts, and then guides engineers through modeling, functional design validation, design implementation, electrical analysis, and release to manufacturing. Writing from the engineer’s perspective, he covers underlying EDA tool algorithms, flows, criteria for assessing project status, and key tradeoffs and interdependencies. This fresh and accessible tutorial will be valuable to all VLSI system designers, senior undergraduate or graduate students of microelectronics design, and companies offering internal courses for engineers at all levels. Reflect complexity, cost, resources, and schedules in planning a chip design project Perform hierarchical design decomposition, floorplanning, and physical integration, addressing DFT, DFM, and DFY requirements Model functionality and behavior, validate designs, and verify formal equivalency Apply EDA tools for logic synthesis, placement, and routing Analyze timing, noise, power, and electrical issues Prepare for manufacturing release and bring-up, from mastering ECOs to qualification This guide is for all VLSI system designers, senior undergraduate or graduate students of microelectronics design, and companies offering internal courses for engineers at all levels. It is applicable to engineering teams undertaking new projects and migrating existing designs to new technologies.

Resistance and capacitance (RC) extraction is an essential step in modeling the interconnection wires and substrate coupling effect in nanometer-technology integrated circuits (IC). The field-solver techniques for RC extraction guarantee the accuracy of modeling, and are becoming increasingly important in meeting the demand for accurate modeling and simulation of VLSI designs. Advanced Field-Solver Techniques for RC Extraction of Integrated Circuits presents a systematic introduction to, and treatment of, the key field-solver methods for RC extraction of VLSI interconnects and substrate coupling in mixed-signal ICs. Various field-solver techniques are explained in detail, with real-world examples to illustrate the advantages and disadvantages of each algorithm. This book will benefit graduate students and researchers in the field of electrical and computer engineering as well as

engineers working in the IC design and design automation industries. Dr. Wenjian Yu is an Associate Professor at the Department of Computer Science and Technology at Tsinghua University in China; Dr. Xiren Wang is a R&D Engineer at Cadence Design Systems in the USA.

This book presents an excellent collection of contributions addressing different aspects of high-level synthesis from both industry and academia. It includes an overview of available EDA tool solutions and their applicability to design problems.

This book serves as a hands-on guide to timing constraints in integrated circuit design. Readers will learn to maximize performance of their IC designs, by specifying timing requirements correctly. Coverage includes key aspects of the design flow impacted by timing constraints, including synthesis, static timing analysis and placement and routing. Concepts needed for specifying timing requirements are explained in detail and then applied to specific stages in the design flow, all within the context of Synopsys Design Constraints (SDC), the industry-leading format for specifying constraints.

The second of two volumes in the Electronic Design Automation for Integrated Circuits Handbook, Second Edition, Electronic Design Automation for IC Implementation, Circuit Design, and Process Technology thoroughly examines real-time logic (RTL) to GDSII (a file format used to transfer data of semiconductor physical layout) design flow, analog/mixed signal design, physical verification, and technology computer-aided design (TCAD). Chapters contributed by leading experts authoritatively discuss design for manufacturability (DFM) at the nanoscale, power supply network design and analysis, design modeling, and much more. New to This Edition: Major updates appearing in the initial phases of the design flow, where the level of abstraction keeps rising to support more functionality with lower non-recurring engineering (NRE) costs Significant revisions reflected in the final phases of the design flow, where the complexity due to smaller and smaller geometries is compounded by the slow progress of shorter wavelength lithography New coverage of cutting-edge applications and approaches realized in the decade since publication of the previous edition—these are illustrated by new chapters on 3D circuit integration and clock design Offering improved depth and modernity, Electronic Design Automation for IC Implementation, Circuit Design, and Process Technology provides a valuable, state-of-the-art reference for electronic design automation (EDA) students, researchers, and professionals.

This book introduces techniques that advance the capabilities and strength of modern software tools for physical synthesis, with the ultimate goal to improve the quality of leading-edge semiconductor products. It provides a comprehensive introduction to physical synthesis and takes the reader methodically from first principles through state-of-the-art optimizations used in cutting edge industrial tools. It explains how to integrate chip optimizations in novel ways to create powerful circuit transformations that help satisfy performance requirements.

Presenting a comprehensive overview of the design automation algorithms, tools, and methodologies used to design integrated circuits, the Electronic Design Automation for Integrated Circuits Handbook is available in two volumes. The first volume, EDA for IC System Design, Verification, and Testing, thoroughly examines system-level design, microarchitectural design, logical verification, and testing. Chapters contributed by leading experts authoritatively discuss processor modeling and design tools, using performance metrics to select microprocessor cores for IC designs, design and verification languages, digital simulation, hardware acceleration and emulation, and much more. Save on the complete set.

This book addresses the automatic sizing and layout of analog integrated circuits (ICs) using deep learning (DL) and artificial neural networks (ANN). It explores an innovative approach to automatic circuit sizing where ANNs learn patterns from previously optimized design solutions. In opposition to classical optimization-based sizing strategies, where computational intelligence techniques are used to iterate over the map from devices' sizes to circuits' performances provided by design equations or circuit simulations, ANNs are shown to be capable of solving analog IC sizing as a direct map from specifications to the devices' sizes. Two separate ANN architectures are proposed: a Regression-only model and a Classification and Regression model. The goal of the Regression-only model is to learn design patterns from the studied circuits, using circuit's performances as input features and devices' sizes as target outputs. This model can size a circuit given its specifications for a single topology. The Classification and Regression model has the same capabilities of the previous model, but it can also select the most appropriate circuit topology and its respective sizing given the target specification. The proposed methodology was implemented and tested on two analog circuit topologies.

This book originated from a workshop held at the DATE 2005 conference, namely Designing Complex SOCs. State-of-the-art in issues related to System-on-Chip (SoC) design by leading experts in the fields, it covers IP development, verification, integration, chip implementation, testing and software. It contains valuable academic and industrial examples for those involved with the design of complex SOCs.

This book covers the fundamental knowledge of layout design from the ground up, addressing both physical design, as generally applied to digital circuits, and analog layout. Such knowledge provides the critical awareness and insights a layout designer must possess to convert a structural description produced during circuit design into the physical layout used for IC/PCB fabrication. The book introduces the technological know-how to transform silicon into functional devices, to understand the technology for which a layout is targeted (Chap. 2). Using this core technology knowledge as the foundation, subsequent chapters delve deeper into specific constraints and aspects of physical design, such as interfaces, design rules and libraries (Chap. 3), design flows and models (Chap. 4), design steps (Chap. 5), analog design specifics (Chap. 6), and finally reliability measures (Chap. 7). Besides serving as a textbook for engineering students, this book is a foundational reference for today's circuit designers.